SCAS789A - NOVEMBER 2004 - REVISED JANUARY 2008

- Qualified for Automotive Applications
- 2-V to 6-V V_{CC} Operation
- Inputs Accept Voltages to 6 V
- Max t_{pd} of 7.5 ns at 5 V

description/ordering information

The SN74AC08 device is a quadruple 2-input positive-AND gate. This device performs the Boolean function $Y = A \bullet B$ or $Y = \overline{A} + \overline{B}$ in positive logic.

1Y [3 12] 4A 2A [4 11] 4Y 2B [5 10] 3B	DO		n pa P Vie		AC	GE
GND 7 8 3Y	1B 1Y 2A 2B 2Y	3	υ	13 12 11 10 9		4Y 3B 3A

ORDERING INFORMATION[†]

T _A	PACKAGE	E ‡	ORDERABLE PART NUMBER	TOP-SIDE MARKING
1000 10 10500	SOIC – D	Tape and reel	SN74AC08QDRQ1	AC08Q
–40°C to 125°C	TSSOP – PW	Tape and reel	SN74AC08QPWRQ1	AC08Q

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

[‡] Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

F	JNCTION [·] (each ga	
INP	UTS	OUTPUT
Α	В	Y
Н	Н	Н
L	Х	L
х	L	L

logic diagram, each gate (positive logic)





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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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SN74AC08-Q1 QUADRUPLE 2-INPUT POSITIVE-AND GATE

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Storage temperature range, T _{stg}

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
V _{CC}	High-level input voltage Low-level input voltage Input voltage Output voltage High-level output current Low-level output current		2	6	V
		V _{CC} = 3 V	2.1		
V _{iH}	High-level input voltage	$V_{CC} = 4.5 V$	3.15		v
		V _{CC} = 5.5 V	3.85		
		V _{CC} = 3 V		0.9	
VIL	Low-level input voltage	V _{CC} = 4.5 V		1.35	v
		V _{CC} = 5.5 V		1.65	
VI	High-level input voltage Low-level input voltage Input voltage Output voltage High-level output current Low-level output current		0	V_{CC}	V
Vo	High-level input voltage Low-level input voltage Input voltage Output voltage High-level output current Low-level output current		0	V _{CC}	V
		V _{CC} = 3 V		-12	
IOH	High-level output current	V _{CC} = 4.5 V		-24	mA
		V _{CC} = 5.5 V		-24	
		V _{CC} = 3 V		12	
l _{OL}	Low-level output current	$V_{CC} = 4.5 V$		24	mA
		V _{CC} = 5.5 V		24	
$\Delta t/\Delta v$	Input transition rise or fall rate			8	ns/V
T _A	Operating free-air temperature		-40	125	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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PARAMETER	TEST CONDITIONS	Vcc	т	A = 25°C	;	T _A = - TO 12		T _A = - TO 8		UNIT
			MIN	ТҮР	MAX	MIN	MAX	MIN	MAX	
		3 V	2.9			2.9		2.9		
	I _{OH} = -50 μA	4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
V _{OH}	$I_{OH} = -12 \text{ mA}$	3 V	2.56			2.4		2.46		V
		4.5 V	3.86			3.7		3.76		
	I _{OH} = -24 mA	5.5 V	4.86			4.7		4.76		
		3 V		0.002	0.1		0.1		0.1	
	I _{OL} = 50 μA	4.5 V		0.001	0.1		0.1		0.1	
		5.5 V		0.001	0.1		0.1		0.1	.,
V _{OL}	I _{OL} = 12 mA	3 V			0.36		0.5		0.44	V
		4.5 V			0.36		0.5		0.44	
	$I_{OL} = 24 \text{ mA}$	5.5 V			0.36		0.5		0.44	
II A or B ports	V _I = V _{CC} or GND	5.5 V			±0.1		±1		±1	μA
I _{CC}	$V_{I} = V_{CC}$ or GND, $I_{O} = 0$	5.5 V			2		40		20	μA
Ci	VI = V _{CC} or GND	5 V		4.5						pF

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T _A = 25°C			T _A = −40°C TO 125°C		T _A = −40°C TO 85°C		UNIT
	(INPUT)		MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A or B	V	1.5	7.5	9.5	1	12.5	1	10	
t _{PHL}	AUIB	T	1.5	7	8.5	1	11.5	1	9	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V $\pm\,$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T _A = 25°C			T _A = −40°C TO 125°C		T _A = −40°C TO 85°C		UNIT
	(INPUT)	(001901)	MIN	ТҮР	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A or B	Y	1.5	5.5	7.5	1	9	1	8.5	
t _{PHL}	A or B		1.5	5.5	7	1	8.5	1	7.5	ns

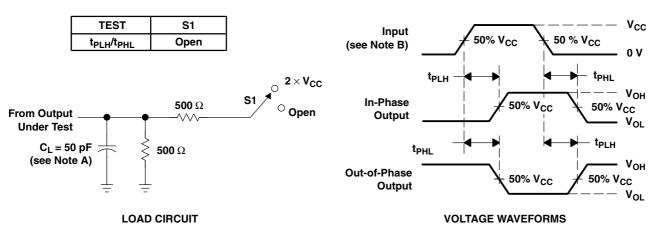
operating characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST	CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance	C _L = 50 pF,	f = 1 MHz	20	pF



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_r \leq 2.5 ns, t_f \leq 2.5 ns.
- C. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SN74AC08QDRG4Q1	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AC08Q	Samples
SN74AC08QPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AC08Q	Samples
SN74AC08QPWRQ1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AC08Q	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN74AC08-Q1 :

• Catalog: SN74AC08

• Enhanced Product: SN74AC08-EP

Military: SN54AC08

NOTE: Qualified Version Definitions:

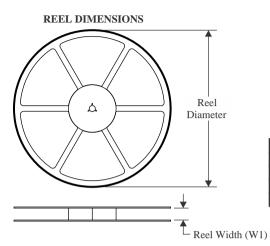
- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications

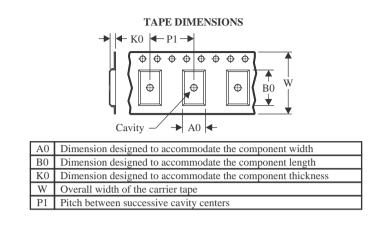


Texas

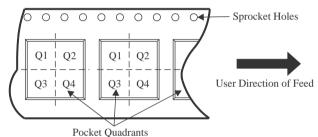
STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



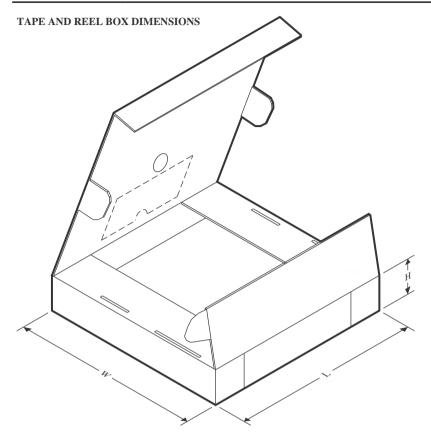
*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AC08QPWRG4Q1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74AC08QPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



www.ti.com

PACKAGE MATERIALS INFORMATION

3-Jun-2022



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AC08QPWRG4Q1	TSSOP	PW	14	2000	356.0	356.0	35.0
SN74AC08QPWRQ1	TSSOP	PW	14	2000	356.0	356.0	35.0

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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